

Microelectronics, BSc course

Basic semiconductor physics

Summary of the essential semiconductor physics

- Charge carriers in semiconductors
- Currents in semiconductors
- Generation, recombination; continuity equation

Energy bands in the lattice

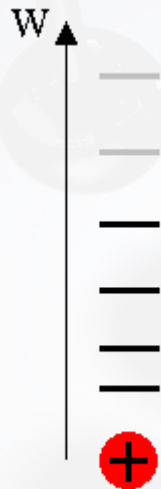
- Basic consequences of quantum mechanics:
 - Positive nucleus (p^+ , n^0) – Negative electrons
 - **Pauli theorem:** two e^- cannot be on the same state; in one electron orbital max two e^- with opposite spin
 - Energy minimum: lowest shells, orbitals are filled
 - Switching between shells: energy gained (equals the energy between the actual state and the unfilled shells)
 - It is most likely that the e^- with upper most state will gain more energy



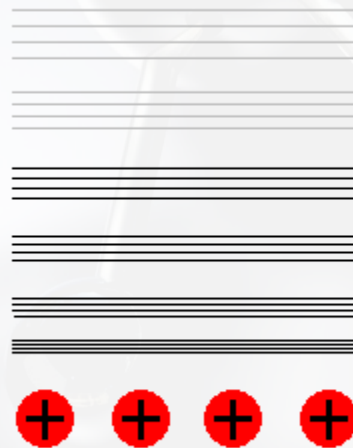
Energy bands

- Resulting from principles of quantum physics

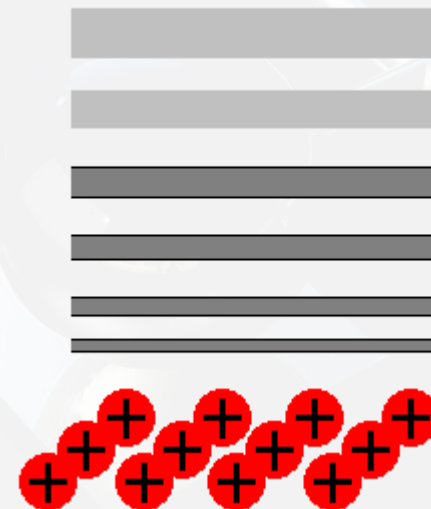
Discrete energy levels:



More atoms – more energy levels of electrons:

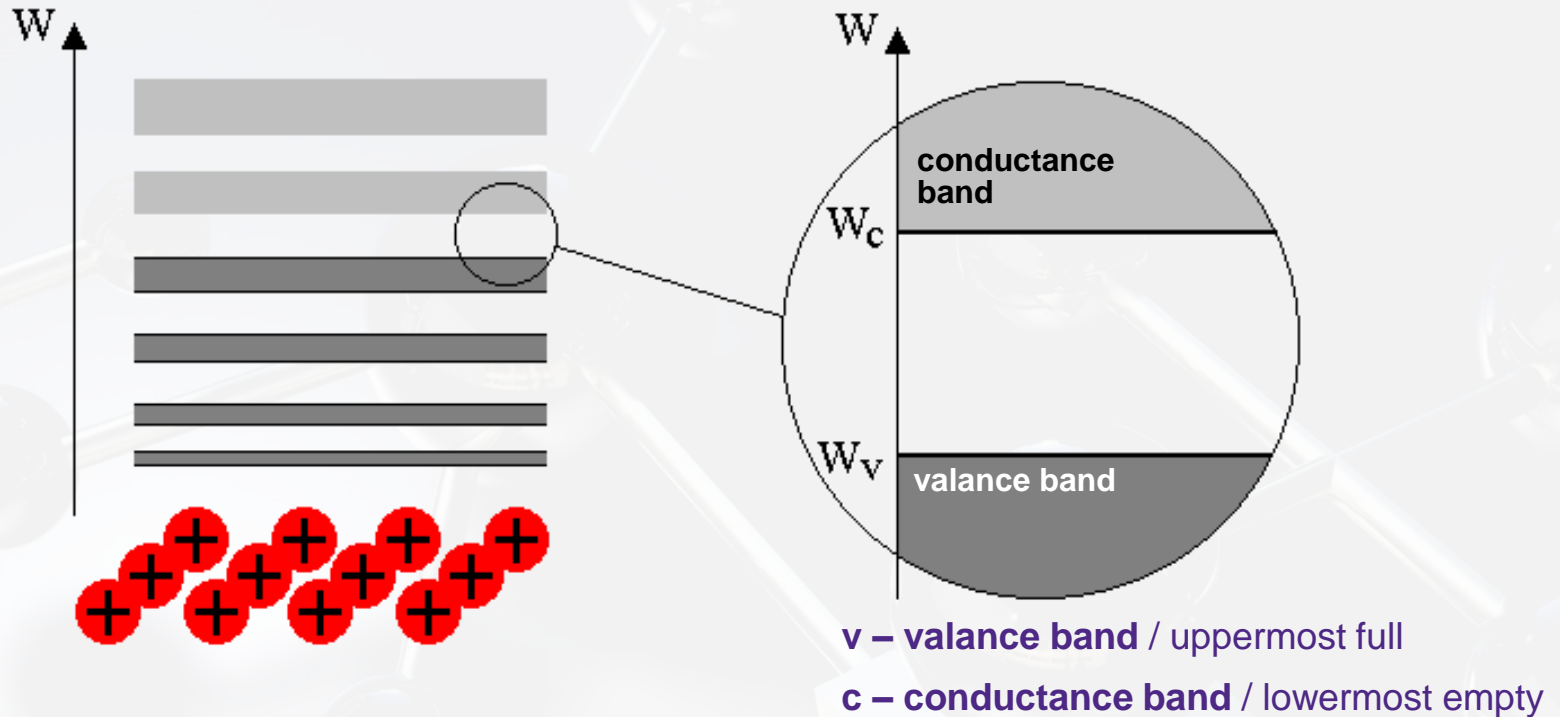


There are so many of them that they form energy bands:



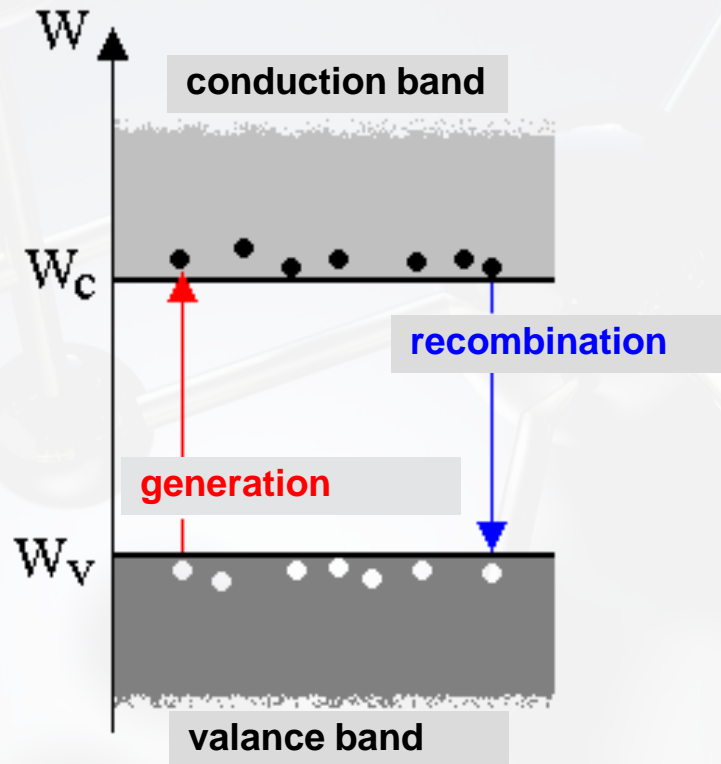
The discrete (allowed) energy levels of an atom become energy bands in a crystal lattice

Valance band, conductance band



- Valance band – these electrons form the chemical bonds
 - almost full
- Conductance band – electrons here can move freely
 - almost empty

Electrons and holes

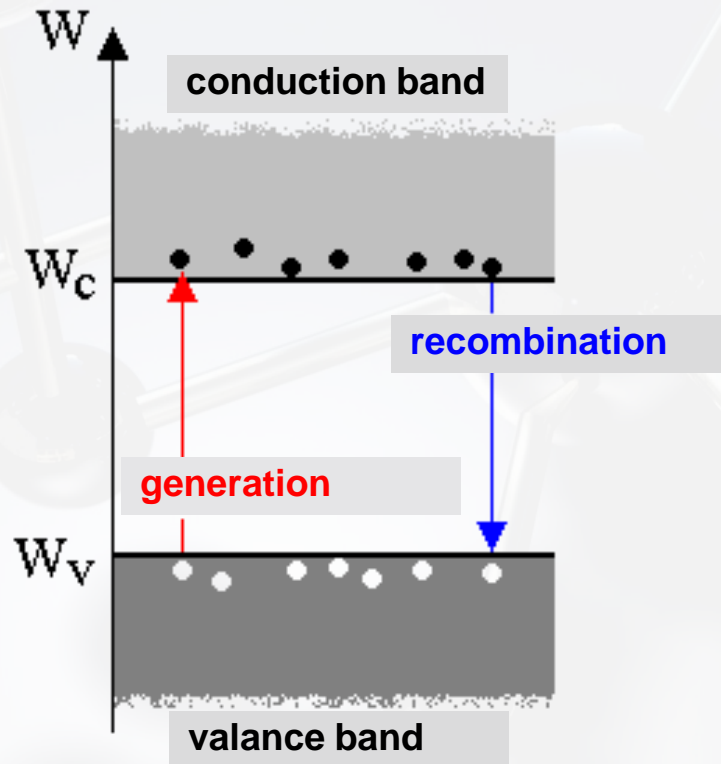


- Generation: using the average thermal energy
- **Electrons:** in the bottom of the conduction band
- **Holes:** in the top of the valance band
- Both the electrons and the holes form the electrical current

Electron: negative charge, positive eff. mass

Hole: positive charge, positive eff. mass

Electrons and holes



How does the electrons gain energy?

► Thermal excitation

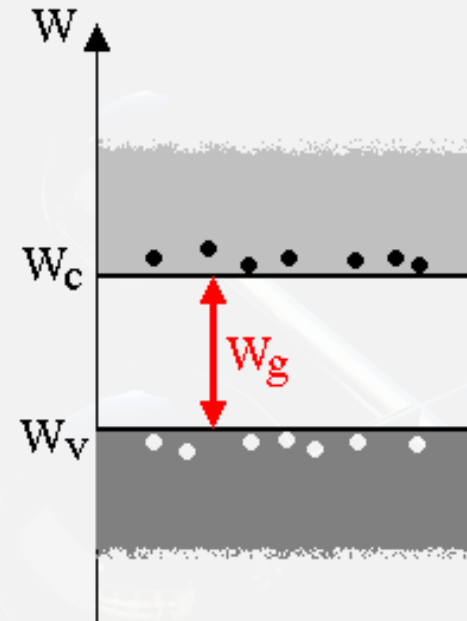
- Energy of lattice resonance transferred to the e^-

► Photon excitation

- Incident light with energy greater than W_g
- $E = h \cdot \nu$

The electron density of the conductance band is determined by the dynamic balance of the generation and the recombination

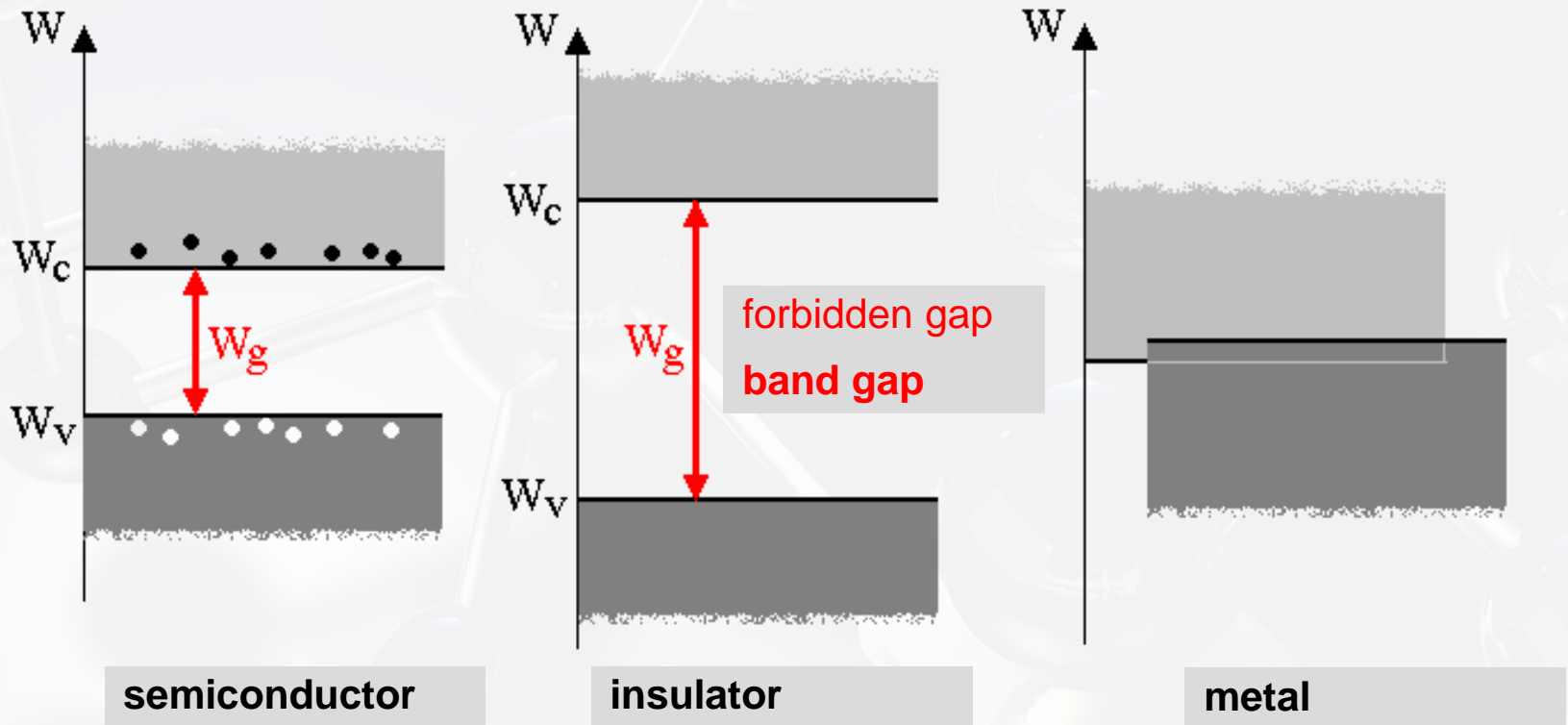
Conductors and insulators



semiconductor

Electron cannot be located in the forbidden gap!

Conductors and insulators

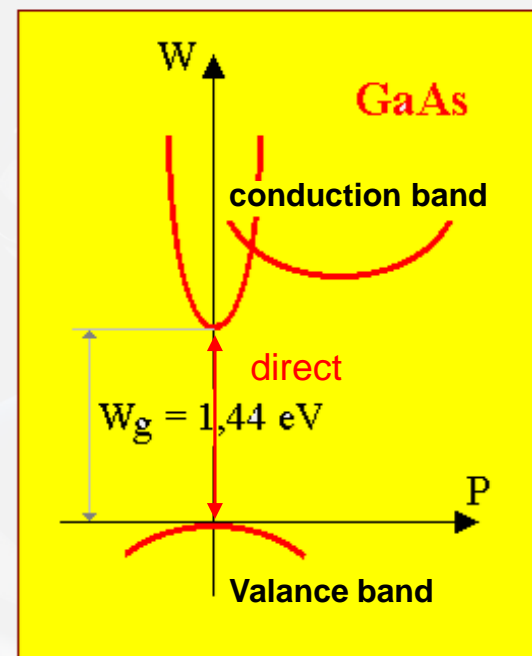
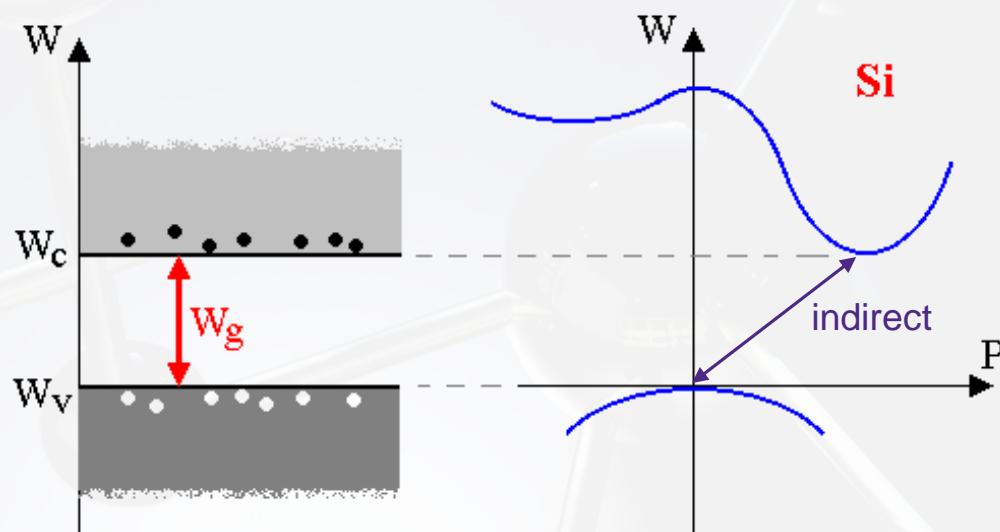


For Si: $W_g = 1.12 \text{ eV}$

for SiO_2 : $W_g = 4.3 \text{ eV}$

$$1 \text{ eV} = 0.16 \text{ aJ} = 0.16 \cdot 10^{-18} \text{ J}$$

Band structure of semiconductors



In case of indirect band semiconductor the laws of energy and impulse conservations must be fulfilled.

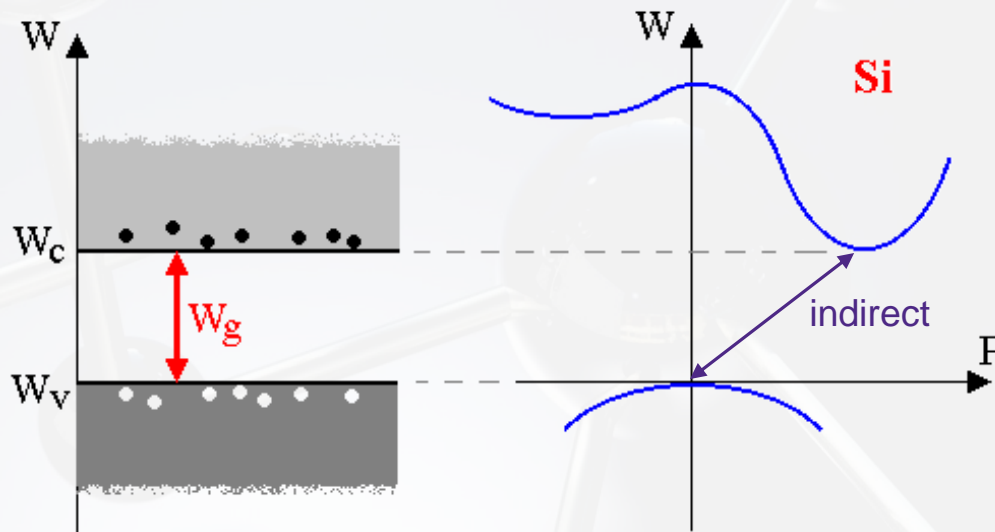
$$F = \frac{dP}{dt}$$

$$P = \frac{h}{2\pi} k$$

GaAs: direct band \Rightarrow opto-electronic devices (LEDs)

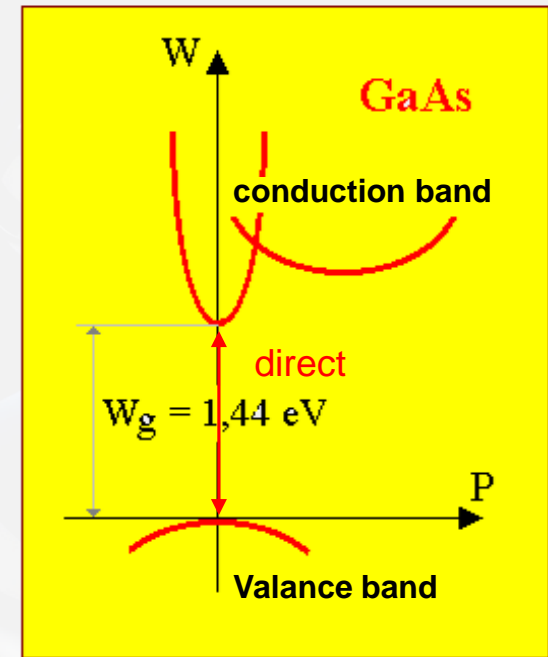
Si: indirect band

Band structure of semiconductors



$$W = \frac{1}{2m} p^2$$

$$W = \frac{1}{2m_{eff}} P^2$$



$$F = \frac{dP}{dt}$$

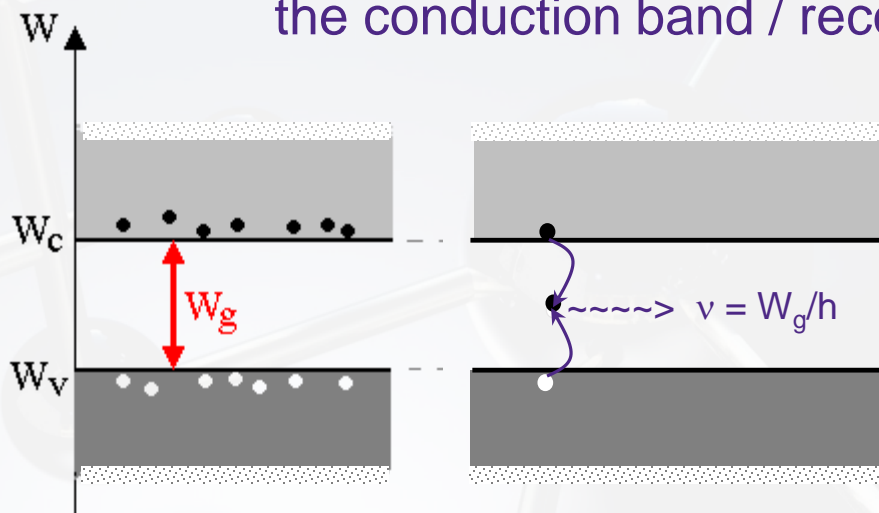
$$P = \frac{h}{2\pi} k$$

GaAs: direct band \Rightarrow opto-electronic devices (LEDs)

Si: indirect band

Generation / recombination

Spontaneous process: thermal excitation – jump into the conduction band / recombination → equilibrium



$$\nu = \frac{W_g}{h}$$

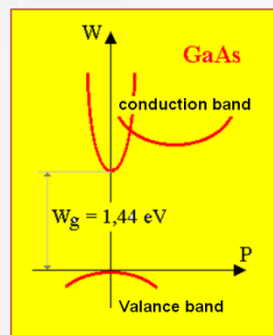
$$\lambda = \frac{c}{\nu}$$

In case of red laser

$$W_g \approx 1.5\text{eV}$$

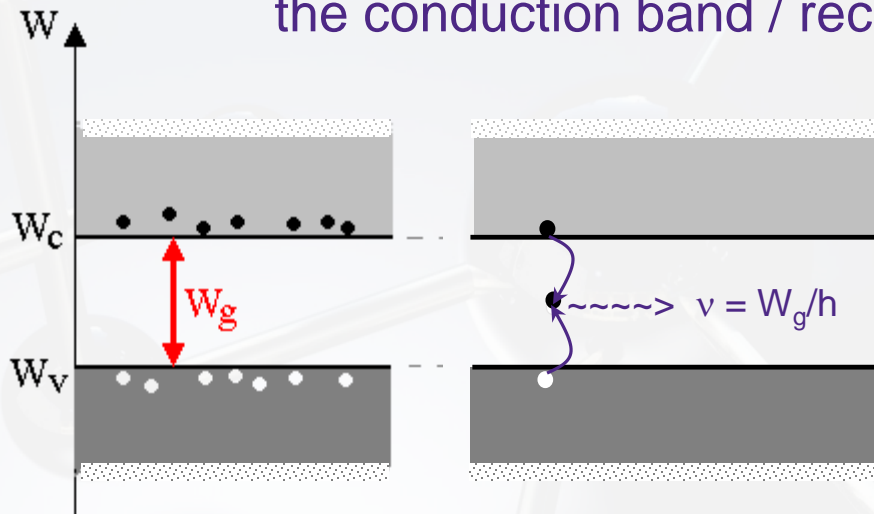
Direct **recombination** may result in light emission (LEDs)

Indirect **recombination** is not radioactive, but always accompanied by heat dissipation (Phonon – lattice vibration)

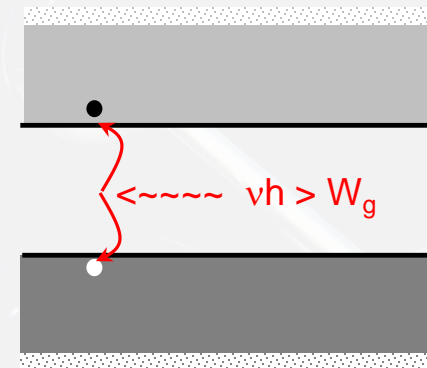


Generation / recombination

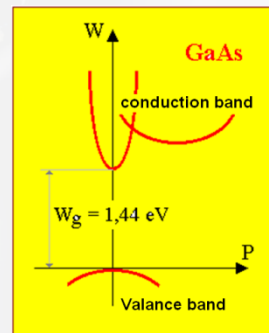
Spontaneous process: thermal excitation – jump into the conduction band / recombination → equilibrium



Direct **recombination** may result in light emission (LEDs)



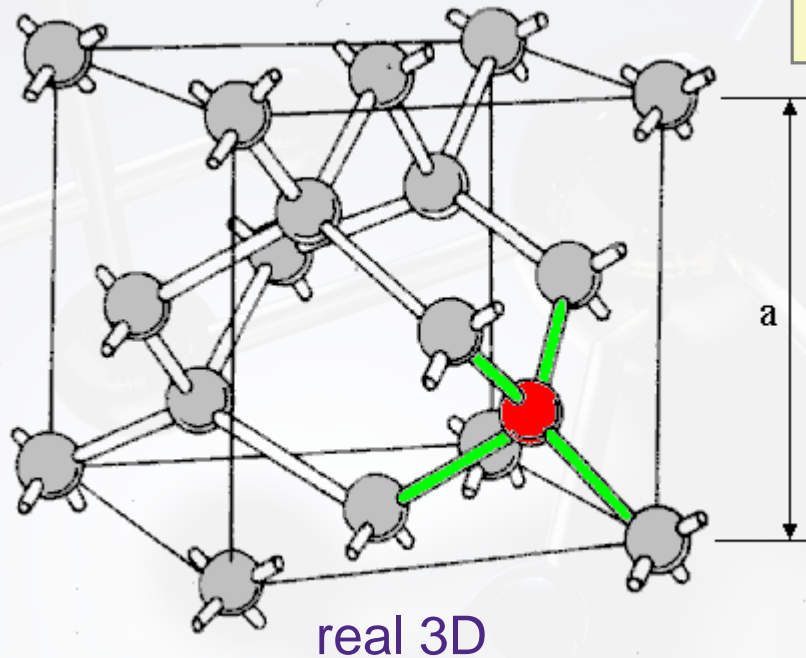
Light absorption results in **generation** (solar cells)



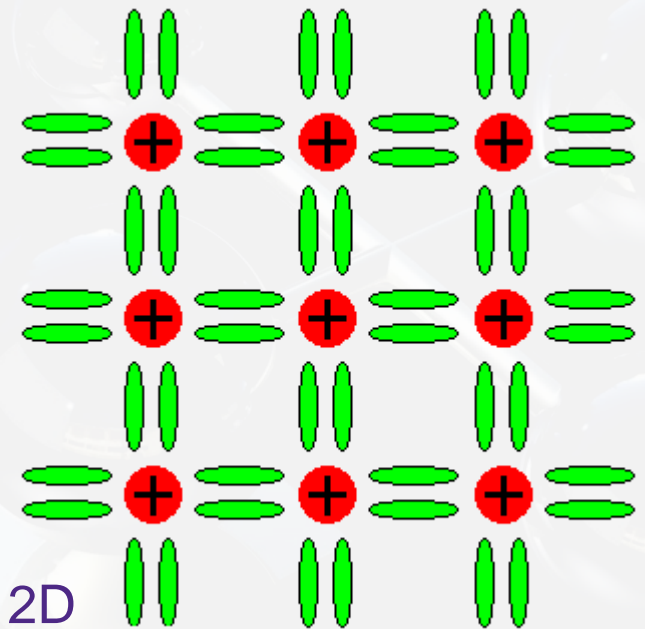
Experiment

Crystalline structure of Si

- Si $N=14$ 4 bonds, *IV*-th column of the periodic table

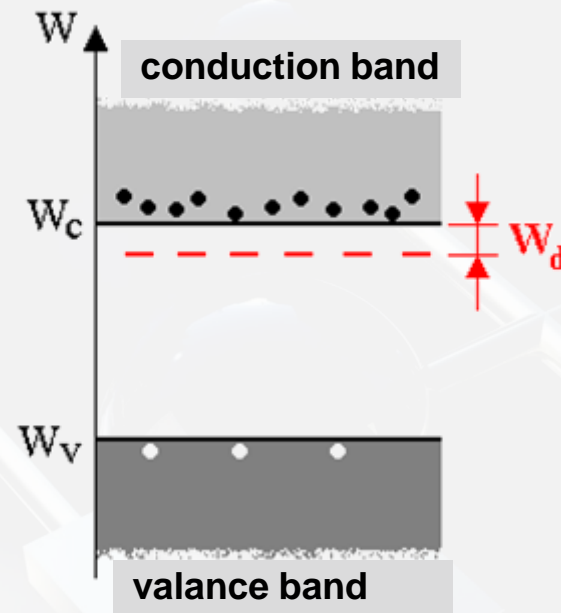
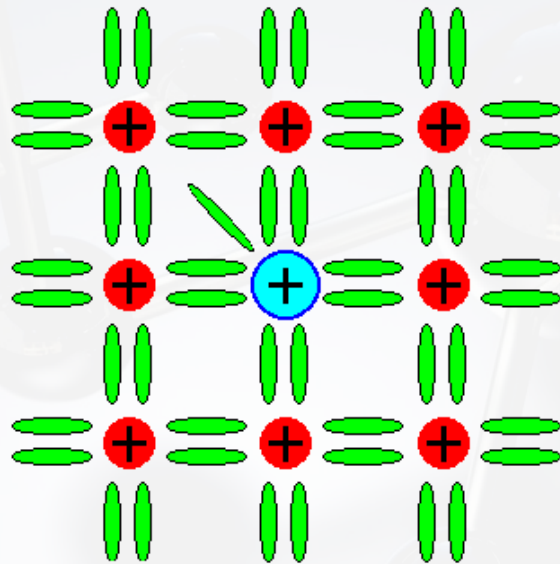


undoped or intrinsic semiconductor



- Diamond lattice, *lattice constant* $a=0.543$ nm
- Each atom has 4 nearest neighbor

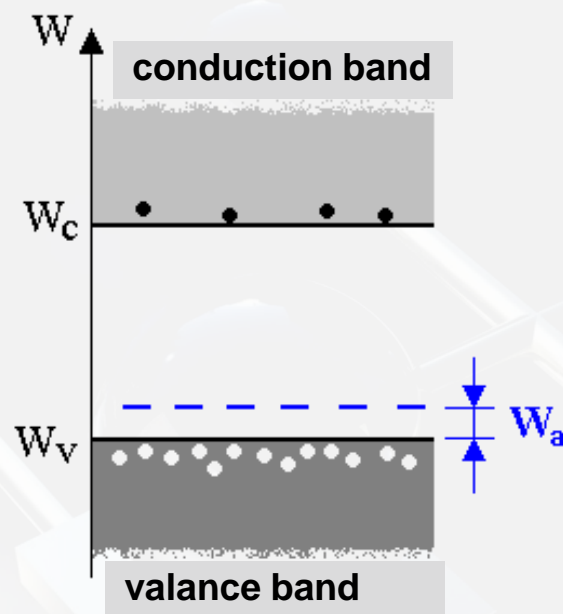
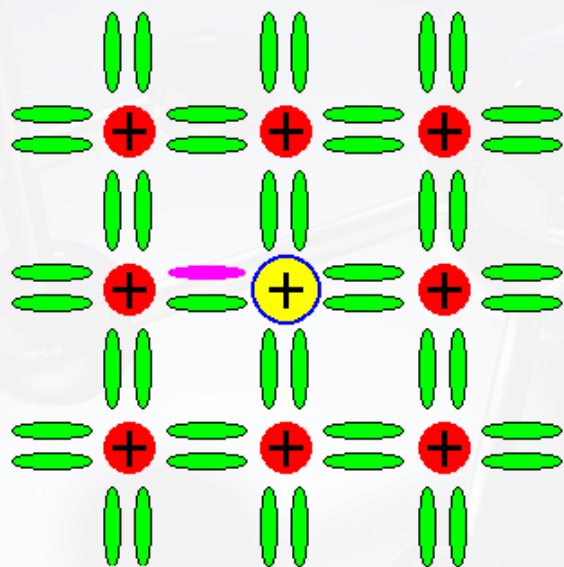
5 valance dopant: **donor** (As, P, Sb)



- **Electron:** *majority* carrier
- **Hole:** *minority* carrier

n-type semiconductor

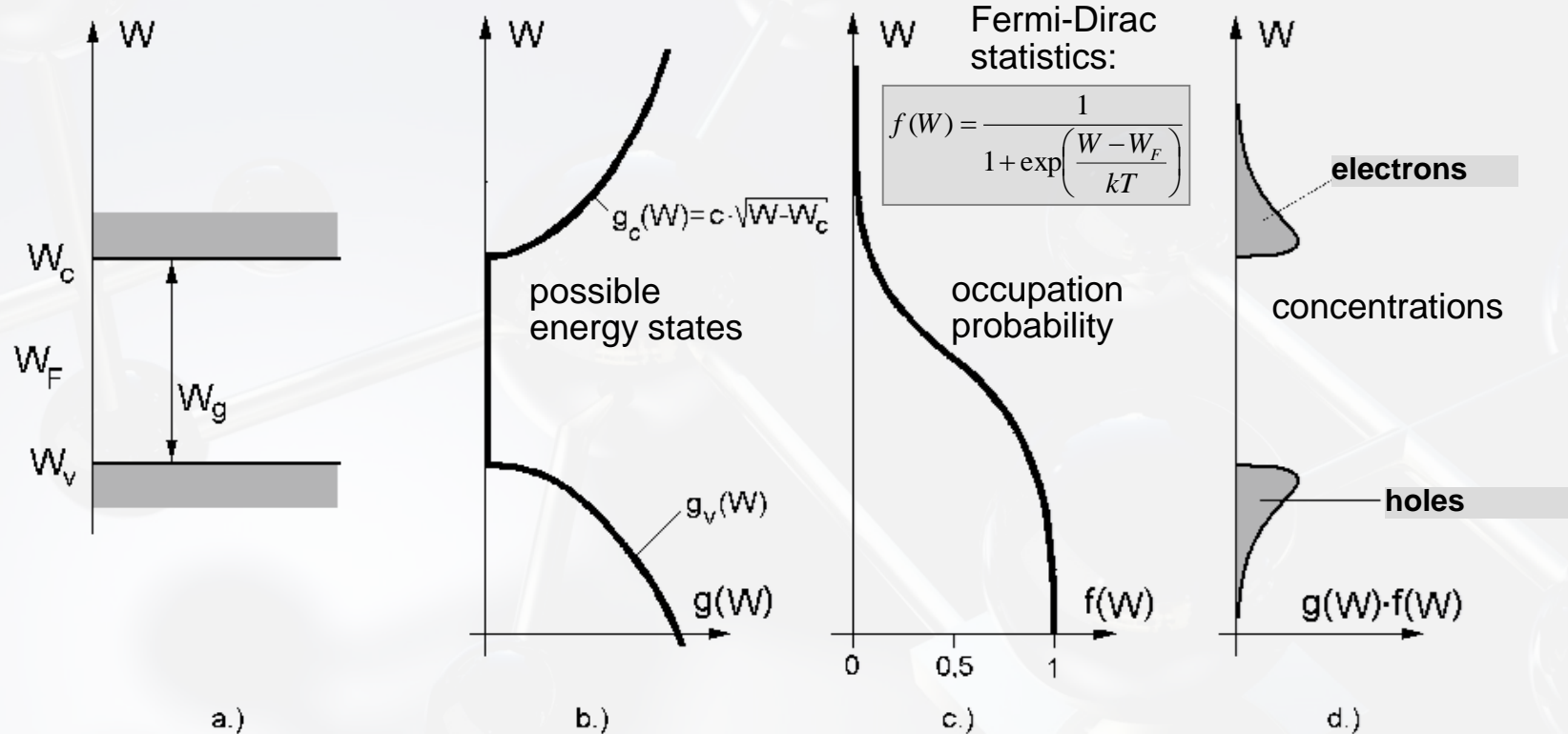
3 valance dopant: **acceptor** (B, Ga, In)



- Electron: *minority* carrier
- Hole: *majority* carrier

p-type semiconductor

Calculation of carrier concentration



$$n = \int_{W_c}^{\infty} g_c(W) f(W) dW$$

$$p = \int_0^{W_v} g_v(W) [1 - f(W)] dW$$

Calculation of carrier concentration

- The results is:

$$n = \text{const } T^{3/2} \exp\left(-\frac{W_c - W_F}{kT}\right)$$

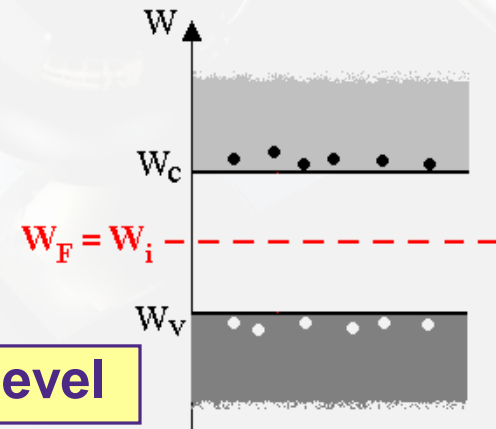
$$p = \text{const } T^{3/2} \exp\left(-\frac{W_F - W_v}{kT}\right)$$

- If there is no doping: $n = p = n_i$
 - it is called ***intrinsic*** material

$$W_c - W_F = W_F - W_v$$

$$W_F = \frac{W_c + W_v}{2} = W_i$$

W_F : Fermi-level

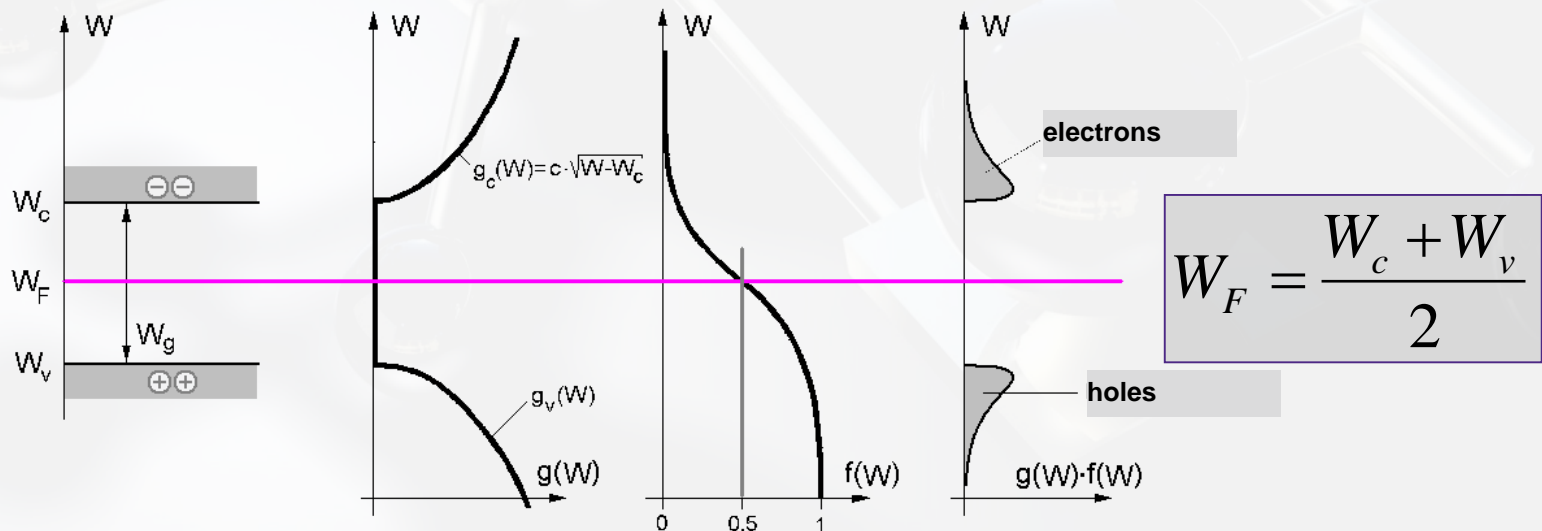


The Fermi-level

- Formal definition of the Fermi-level: the energy level where the probability of occupancy is 0.5:

$$f(W) = \frac{1}{1 + \exp\left(\frac{W - W_F}{kT}\right)} = 0.5$$

- In case of intrinsic semiconductor this is in the middle of the band gap:



- This is the intrinsic Fermi-level W_i

Carrier concentrations

$$n = \text{const } T^{3/2} \exp\left(-\frac{W_c - W_F}{kT}\right)$$

$$p = \text{const } T^{3/2} \exp\left(-\frac{W_F - W_v}{kT}\right)$$

$$n \cdot p = \text{const} \cdot T^3 \exp(-W_g / kT)$$

- **Depends on temperature only**, does not depend on doping concentration

$$n \cdot p = n_i^2$$

Mass action law

For silicon at 300 K absolute temperature

$$n_i = 10^{10} / \text{cm}^3$$

(10^{10} electrons in a cube of size
0.01 mm x 0.01 mm x 0.01 mm)

Carrier concentrations

Problem

- Si, $T = 300\text{ K}$, donor concentration $N_D = 10^{17} / \text{cm}^3$

- **What are the hole and the electron concentrations?**
 - Donor doping $\Rightarrow n \approx N_D = \underline{10^{17} / \text{cm}^3}$
 - Hole concentration: $p = n_i^2 / n = 10^{20} / 10^{17} = \underline{10^3 / \text{cm}^3}$

- **What is the relative density of the dopants?**
 - 1 cm^3 Si contains $5 \cdot 10^{22}$ atoms
 - thus, $10^{17} / 5 \cdot 10^{22} = \underline{2 \cdot 10^{-6}}$

 - The purity of doped Si is 0.999998

Carrier concentrations

$$n = \text{const } T^{3/2} \exp\left(-\frac{W_c - W_F}{kT}\right)$$

$$n_i = \text{const } T^{3/2} \exp\left(-\frac{W_c - W_i}{kT}\right)$$

$$\frac{n}{n_i} = \exp\left(\frac{W_F - W_i}{kT}\right)$$

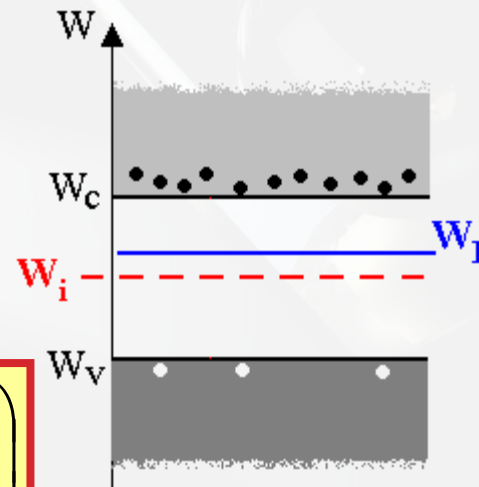
$$n = n_i \exp\left(\frac{W_F - W_i}{kT}\right)$$

$$p = n_i \exp\left(-\frac{W_F - W_i}{kT}\right)$$

- Just re-order the equations

$$\begin{aligned} kT &= 1.38 \cdot 10^{-23} \text{ VAs/K} \cdot 300 \\ K &= 4,14 \cdot 10^{-21} \text{ J} = 0.026 \text{ eV} \\ &= 26 \text{ meV} \end{aligned}$$

Thermal energy



In doped semiconductors the Fermi-level is shifted wrt the intrinsic Fermi-level

Temperature dependence

$$n_i^2 = n \cdot p = \text{const} \cdot T^3 \exp(-W_g / kT)$$

$$\frac{d}{dT} n_i^2 = n_i^2 \left(\frac{3}{T} + \frac{W_g}{kT^2} \right)$$

$$\frac{d n_i^2}{n_i^2} = \left(3 + \frac{W_g}{kT} \right) \frac{dT}{T}$$

► How strong is it for Si?

Problem

$$\frac{d n_i^2}{n_i^2} = \left(3 + \frac{1,12}{0,026} \right) \frac{dT}{300} \cong 0.15 dT \approx 15\% / ^\circ\text{C}$$

Temperature dependence of carrier concentrations

Problem

Si, $T = 300 \text{ K}$, donor dopant concentration $N_D = 10^{17} / \text{cm}^3$

$$n \cong N_D = 10^{17} / \text{cm}^3$$

$$p = n_i^2 / n = 10^{20} / 10^{17} = 10^3 / \text{cm}^3 \quad \Leftarrow n \cdot p = n_i^2$$

How do n and p change, if T is increased by 25 degrees?

$$n \cong N_D = 10^{17} / \text{cm}^3 \text{ – unchanged}$$

$$n_i^2 = 10^{20} \cdot 1.15^{25} = 33 \cdot 10^{20}$$

$$\Rightarrow p = n_i^2 / n = 33 \cdot 10^{20} / 10^{17} = 3.3 \cdot 10^4 / \text{cm}^3$$

Only the minority carrier concentration increased!

$$\Delta T = 16.5 \text{ } ^\circ\text{C} \rightarrow 10\times$$

Currents in semiconductors

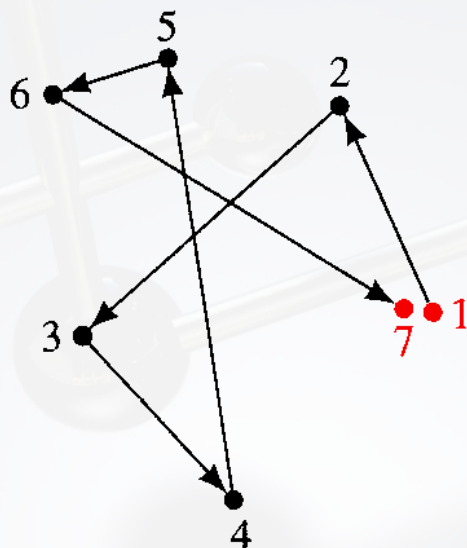
- Drift current
- Diffusion current

Not discussed:

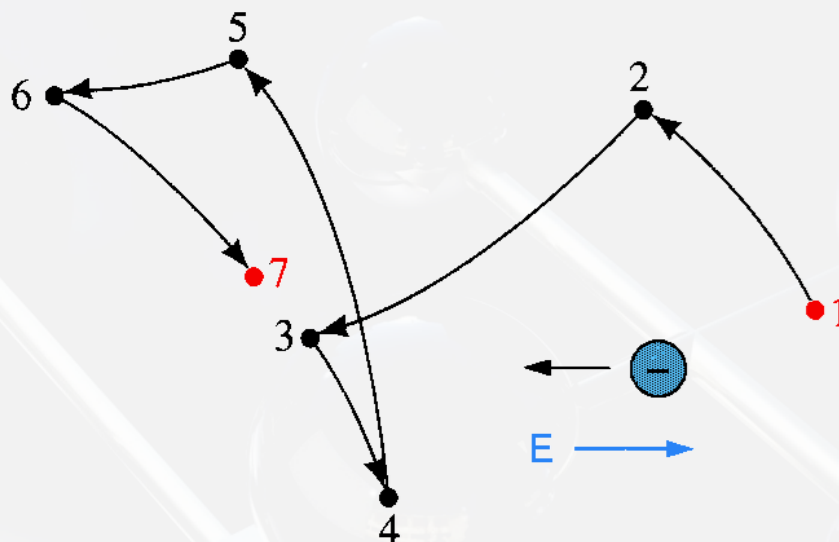
- currents due to temperature gradients
- currents induced by magnetic fields
- energy transport besides carrier transport
- combined transport phenomena

Drift current

Thermal movement of electrons



No electrical field



There is E electrical field

$$\bar{v}_s = \mu \bar{E}$$

μ = mobility
 m^2/Vs

Drift current

$$\bar{J} = \rho \bar{v}$$

ρ charge density
 \bar{v} velocity (average)

$$\bar{v}_s = \mu \bar{E}$$

$$\bar{J}_n = q n \mu_n \bar{E}$$

$$\bar{J}_p = q p \mu_p \bar{E}$$

$$\bar{J} = q (n \mu_n + p \mu_p) \bar{E}$$

$$\bar{J} = \sigma_e \bar{E}$$

Differential
 Ohm's law

$$\rho_e = \frac{1}{\sigma_e}$$

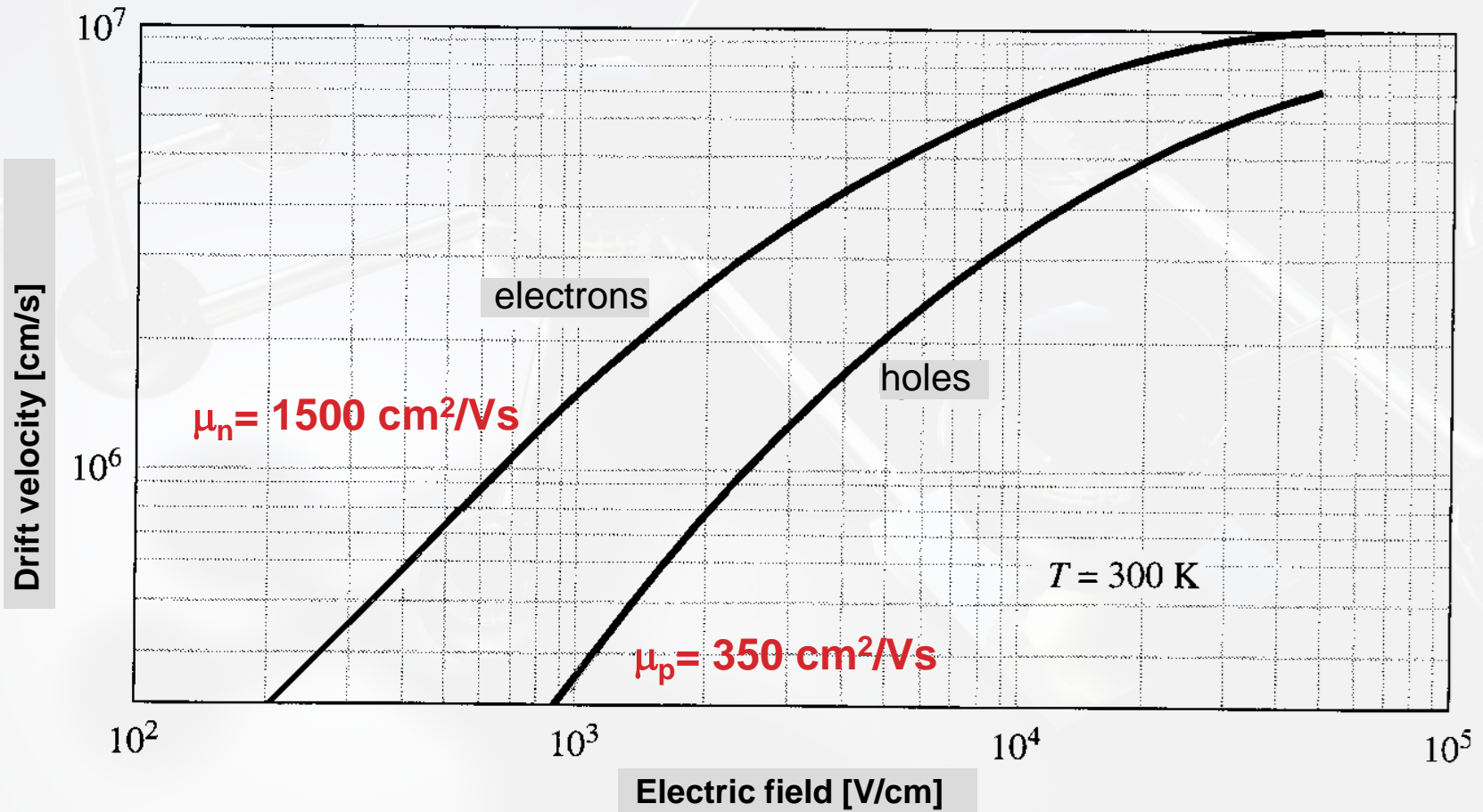
Specific resistance

$$\sigma_e = q (n \mu_n + p \mu_p)$$

Specific electrical conductivity of the
 semiconductor

Carrier mobilities

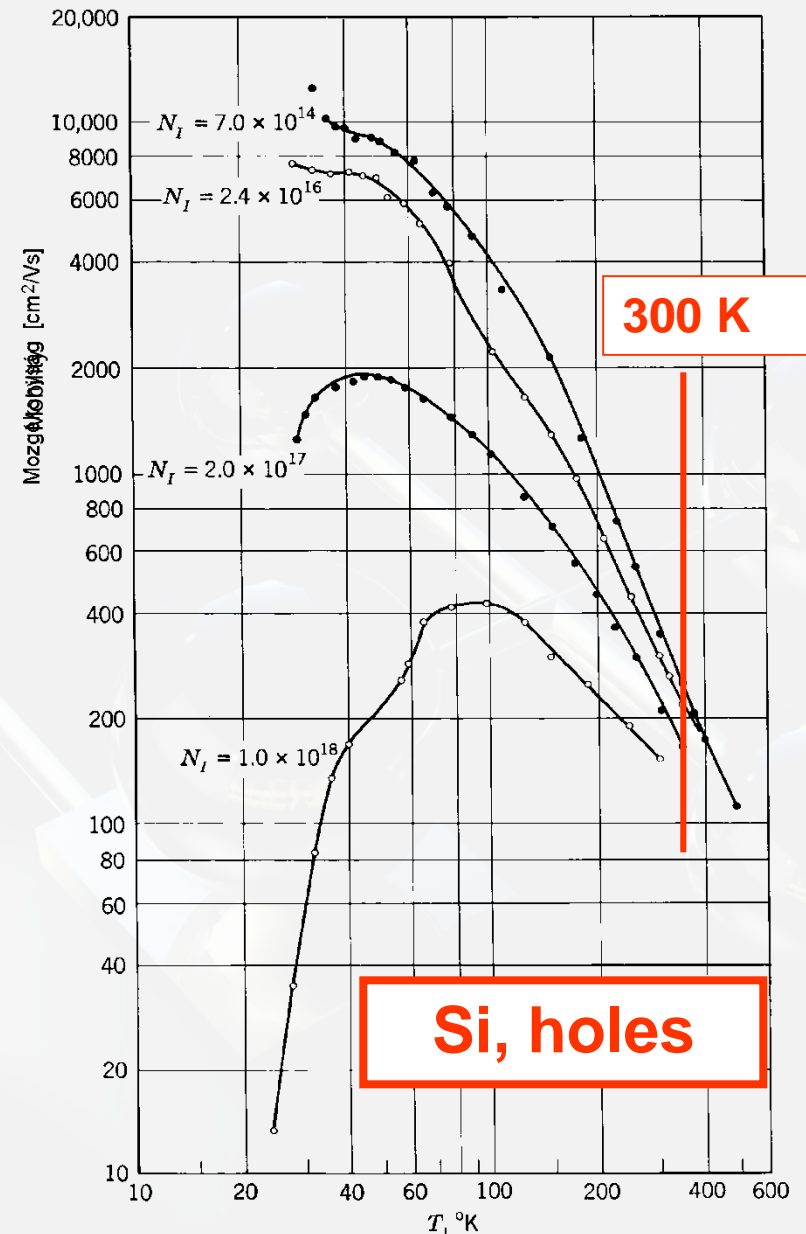
Si



Carrier mobilities

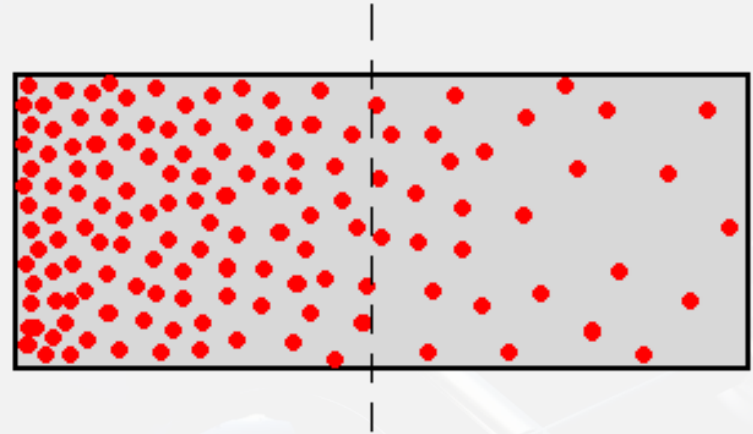
- Mobility decreases with increasing doping concentration
- At around room temperature mobilities decrease as temperature increases

$$\mu \sim T^{-3/2}$$



Diffusion current

- Reasons:
 - concentration difference (gradient)
 - thermal movement
- Proportional to the gradient
- D: diffusion constant [m^2/s]



$$\overline{J}_n = q D_n \overline{\text{grad } n}$$

$$\overline{J}_p = -q D_p \overline{\text{grad } p}$$

Total currents

$$\overline{J}_n = qn\mu_n \overline{E} + q D_n \text{grad } n$$

$$\overline{J}_p = qp\mu_p \overline{E} - q D_p \text{grad } p$$

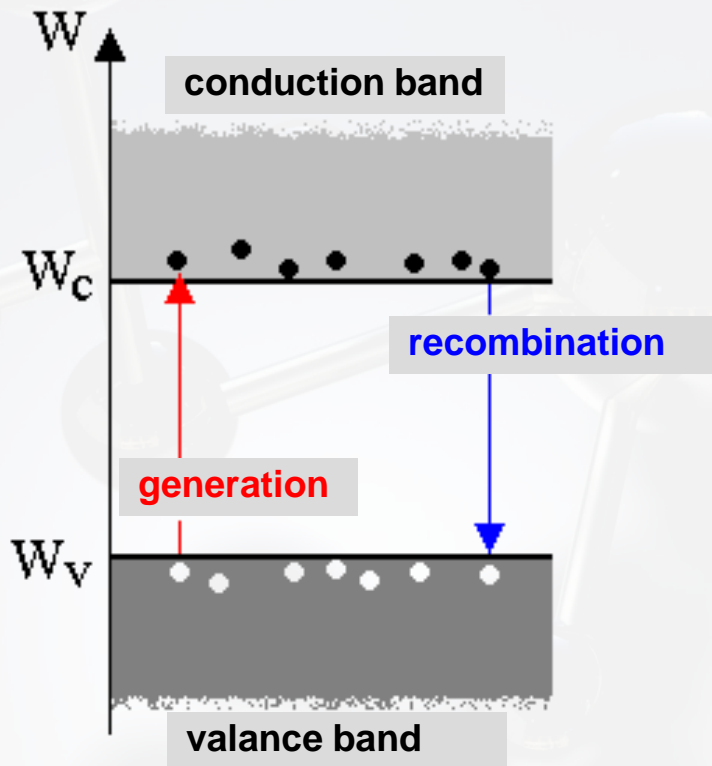
$$D = \frac{kT}{q} \mu$$

Einstein's relationship

$$U_T = \frac{kT}{q} \Big|_{T=300K} = \frac{1.38 \cdot 10^{-23} [\text{VAs/K}] \cdot 300[\text{K}]}{1.6 \cdot 10^{-19} [\text{As}]} \cong 0.026 \text{ V} = 26 \text{ mV}$$

Thermal voltage

Generation, recombination



- **Life-time:** average time an electron spends in the conduction band
 - This value is influenced by the impurities (recombination centers, allowed states in the band gap)

$$\tau_n, \tau_p$$

1 ns ... 1 μ s

- If: τ_n the life-time of an e^- → probability of recombination within dt time is dt/τ_n
- **Recombination rate:** r [$1/m^3s$]

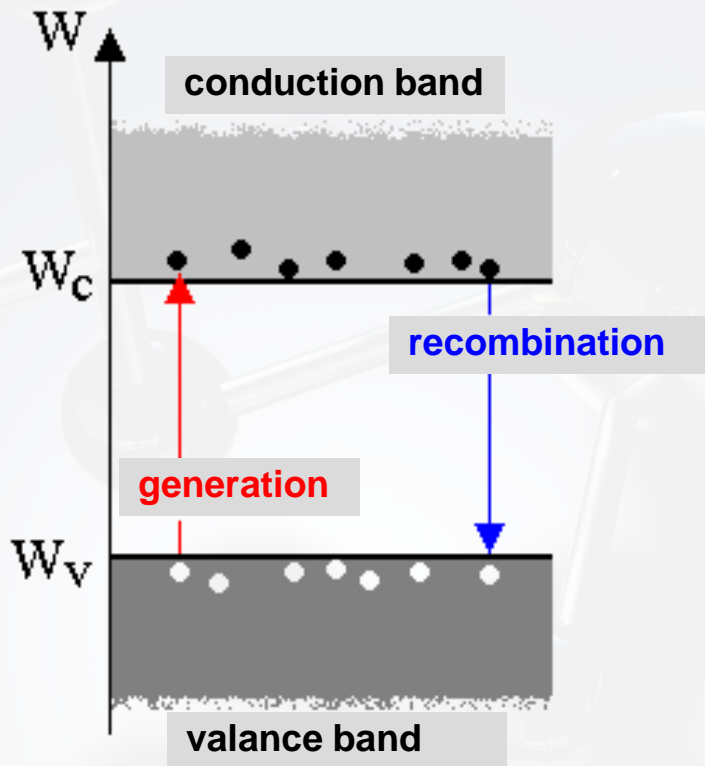
Number of recombined carriers in a unit volume within a unit timeframe.

$$r_n = \frac{n \cdot dt}{\tau_n}$$

unit time,
unit V

$$r_n = \frac{n}{\tau_n}$$

Generation, recombination



$$r_n = \frac{n}{\tau_n}$$

$$r_p = \frac{p}{\tau_p}$$

- **Life-time**: average time an electron spends in the conduction band

$$\tau_n, \tau_p$$

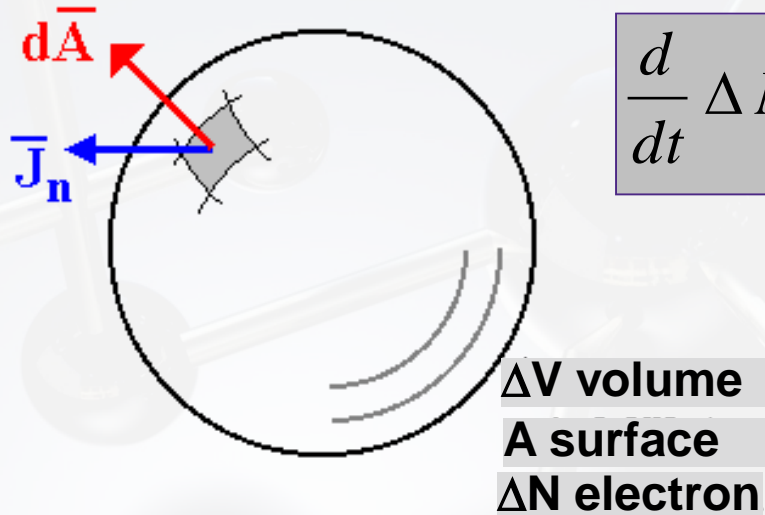
1 ns ... 1 μ s

- **Generation rate**: g [$1/\text{m}^3\text{s}$]

- **Recombination rate**: r [$1/\text{m}^3\text{s}$]

$$g_n = r_n|_{\text{equilibrium}} = \frac{n_0}{\tau_n}$$

Continuity equation



$$\frac{d}{dt} \Delta N = -\frac{1}{-q} \oint_A \bar{J}_n d\bar{A} + g_n \cdot \Delta V - \frac{n}{\tau_n} \Delta V$$

$$\frac{d}{dt} \frac{\Delta N}{\Delta V} = \frac{1}{q} \frac{1}{\Delta V} \oint_A \bar{J}_n d\bar{A} + g_n - \frac{n}{\tau_n}$$



$$\frac{dn}{dt} = \frac{1}{q} \operatorname{div}(\bar{J}_n) + g_n - \frac{n}{\tau_n}$$

Diffusion equation

$$\frac{dn}{dt} = \frac{1}{q} \operatorname{div}(\overline{J}_n) + g_n - \frac{n}{\tau_n}$$

$$\overline{J}_n = qn\mu_n \overline{E} + qD_n \operatorname{grad} n$$

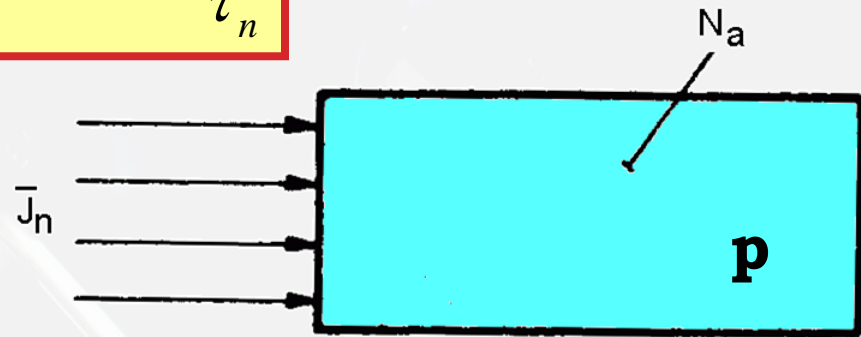
$$\frac{dn}{dt} = \mu_n \operatorname{div}(n\overline{E}) + D_n \operatorname{divgrad} n + g_n - \frac{n}{\tau_n}$$

$$\frac{dp}{dt} = -\mu_p \operatorname{div}(p\overline{E}) + D_p \operatorname{divgrad} p + g_p - \frac{p}{\tau_p}$$

Example for the solution of the diff. eq.:

$$\frac{dn}{dt} = \mu_n \operatorname{div}(n\vec{E}) + D_n \operatorname{divgrad} n + g_n - \frac{n}{\tau_n}$$

- ▶ Si block doped homogenously by p
- ▶ e^- injected with constant current density
- ▶ e^- are moving according to the diffusion ($E=0$) while recombining
- ▶ Steady-state ($dn/dt=0$)



- ▶ What is the $n(x)$ distribution of the injected minority carriers?
- ▶ What is the average penetration depth, prior to recombination?

Example for the solution of the diff. eq.:

$$\frac{dn}{dt} = \mu_n \operatorname{div}(n \bar{E}) + D_n \operatorname{divgrad} n + g_n - \frac{n}{\tau_n}$$

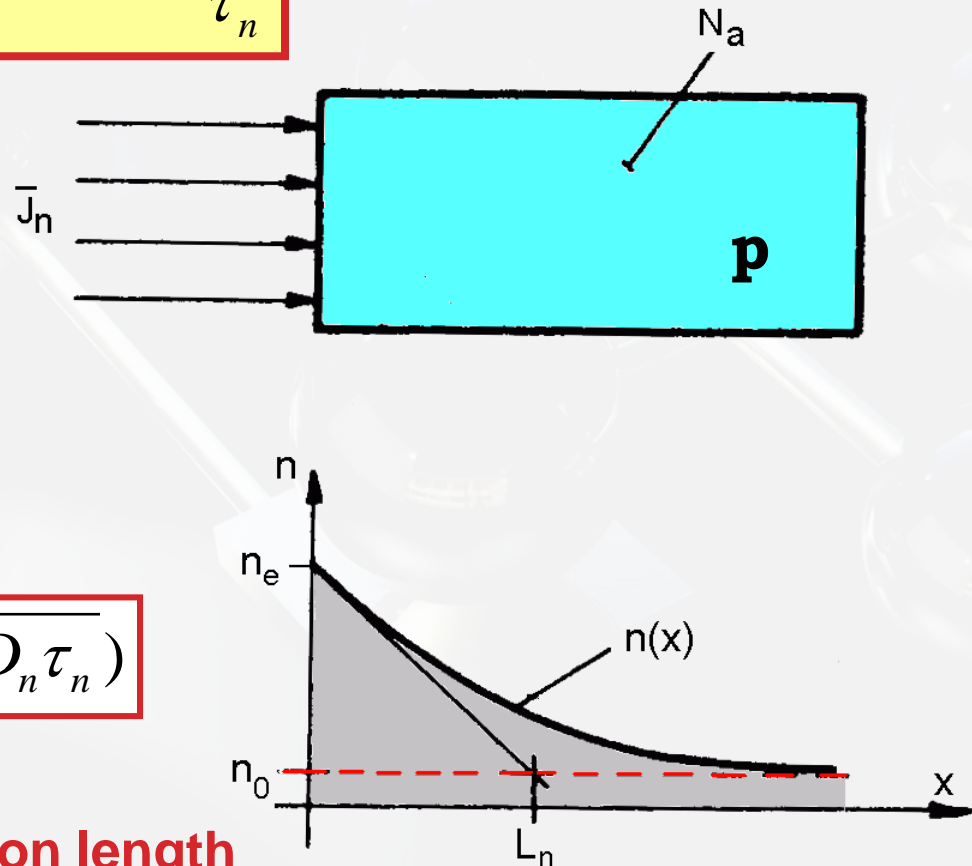
$$0 = D_n \frac{d^2 n}{dx^2} + g_n - \frac{n}{\tau_n}$$

$$0 = D_n \frac{d^2 n}{dx^2} + \frac{n_0}{\tau_n} - \frac{n}{\tau_n}$$

$$n(x) = n_0 + (n_e - n_0) \exp(-x / \sqrt{D_n \tau_n})$$

$$L_n = \sqrt{D_n \tau_n}$$

diffusion length



Omne ignotum pro magnifico.

Everything unknown seems magnificent.
Tacitus, 55-120 AD, Roman historian